

Wrought copper-nickel-silicon alloy NSB 5 alloy 111

NSB 5 is a precipitation-hardenable, low-alloy material with high strength, medium electrical and thermal conductivity. The material is insensitive to stress corrosion cracking and to atmospheric corrosion and complies with the BS 3B 25 and D.T.D 498 standards. The composition lies between the EN materials CW111C CuNi2Si and CW112C CuNi3Si.

ZOLLERN brand	NSB 5	// Phy
EN designation	≈ CuNi2Si	
EN material no:	≈ CW111C	
	BS 3B 25 D.T.D 498	
// National designations / ISO		
DIN	≈ CuNi2Si	
DIN	≈ 2.0855	
ISO	≈ CuNi2Si	
USA	≈ C64700	
GB	BS 3B 25 D.T.D 498	
F	≈ U - N3S	
	≈ (substantial coherence)	
// Composition (weight by per cer	nt in %)	

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Cu		Ni	Si	AI	Fe	Other
	Rest	2.0 - 3.5	0.4 - 0.8	max. 0.02	max. 0.10	max. 0.3

// Strength properties at room temperature				
	(minimum values)			
[1] BS 3B 25 [2] D.T.D 498	R _{p0.2} N/mm²	R _m N/mm²	A₅ %	НВ
[1] Forgings and bars	430	580	12	159- 207
[2] Forgings and bars R _{p0.1} => 417 N/mm ²	-	587	15	-

	Physical properties
8.8 kg/dm³	Density at 20 °C
1040 – 1060°C	Melting temperature/range
	Coefficient of linear expansion
16 x 10⁻⁵ °C⁻¹	from 20° to 200°C
16 x 10 ⁻⁶ °C ⁻¹	from 20° to 300°C
0.381 J/g x °C	Specific heat at 20°C
1.51 W/cm x°C	Thermal conductivity at 20°C
20 - 28 MS/m 34 - 48 % IACS	Electr. conductivity at 20°C
0.0357 - 0.0500 Ω mm²/m	Electr. resistance at 20°C
0.0020 °C ⁻¹	Temperature coefficient of the electrical resistance (0 - 100°C)
< 1.01	Permeability
130 KN/mm²	Young's modulus

/ Dynamic strength values at room temperature (reference values)	
Rotational bending fatigue strength R_{bw} at 20 x10 ⁶ load cycles, 30% cold-formed	180 N/mm²
Notched impact energy (ISO - V/KV)	50 joules



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 Areas of application Due to the favourable combination of properties, NSB 5 is suitable for many areas of technology, also with seawater contact. The material is used among other things for bearings in aircrafts as well as for amagnetic screws, amagnetic sealing rings, 	Relaxation annealing Soft annealing	250 – 400°C soft, solution annealed condition is achieved by annealing 800 - 900°C with subsequent water quenching
 amagnetic bolts, amagnetic flanges amagnetic shafts. 	Soft soldering	after solution annealing at over 450°C with subsequent air cooling
Machinability	Soft soldering	good
NSB 5 has good hot forming properties and can also be cold-formed well in the solution-annealed condition. NSB5 behaves better than pure copper during machining. Flow chips do not form as long.	Brazing	not recommended due to softening
The cutting index is approx. 30 where CuZn39Pb3 = 100.	Welding	not recommended because of softening, preheating is necessary for large parts. A filler material of the same type is not available
	Surface	
	treatment	polishing and chemical structuring is possible, as well as galvanic coatings



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